



## PRODUCT SPECIFICATION

# K265B-UU

**Wi-Fi Dual-band 2x2 + Bluetooth 5.4**

**Combo Module**

Version:v1.4

**Customer:** \_\_\_\_\_

**Customer P/N:** \_\_\_\_\_

**Signature:** \_\_\_\_\_

**Date:** \_\_\_\_\_

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## K265B-UU Module Datasheet

| Ordering Information | Part NO.      | Description   |
|----------------------|---------------|---|
|                      | FGK265BUUX-01 | W265U1,802.11a/b/g/n/ac/ax+BT5.4,2T2R,13*15MM,USB+USB,3 天线，小米专用 |



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## Revision History

[illegible]

## 1. General Description

### 1.1 Introduction

K265B-UU is a Wi-Fi/Bluetooth combo chip supporting 2T2R 802.11ax and Bluetooth 5.4. The Wi-Fi system integrates PMU, MAC, PHY and Radio. It is designed to be fully compliant with IEEE802.11ax (aka Wi-Fi 6) standard and can operate at both 2.4GHz and 5GHz band. The max PHY data rate can reach up to 1201Mbps when operating at 80MHz bandwidth. It supports USB 2.0 host interface.

### 1.2 Description

|                       |   |
|-----------------------|---|
| Model Name            | K265B-UU                                |
| Product Description   | Support Wi-Fi/Bluetooth functionalities |
| Dimension             | L x W x H: 15 x 13 x 2.31 mm            |
| Host Interface        | Support USB/UART                        |
| Operating temperature | -25°C to 85°C                           |
| Storage temperature   | -40°C to 120°C                          |

## 2. Features

### General

- Compliant with IEEE 802.11 a/b/g/n/ac/ax
- Supports two spatial streams 2T2R MIMO
- Supports 20/40/80MHz bandwidth and modulation up to 1024-QAM
- Integrated PA/LNA/TR switch and single-ended RF port for both 2.4GHz and 5GHz
- Wi-Fi and Bluetooth co-existence
- Security features:
  - Supports WEP-40/WEP-104, AES/TKIP/CCMP/GCMP
  - Supports WPA/WPA2/WPA3 personal, WPA2/WPA3 enterprise
  - Supports WPS2.0
  - Supports WAPI

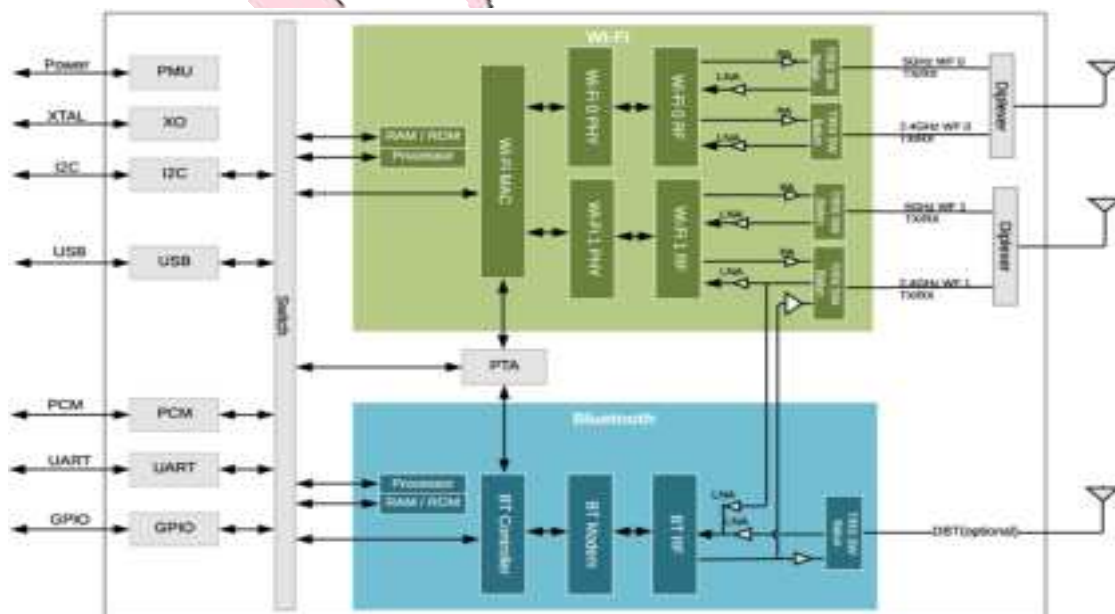
### Host Interface

- High speed UART interface with hardware flow control

### Bluetooth Features

- Supports Bluetooth v5.4 with BLE audio
- Supports dual mode BDR/EDR and BLE
- Backward-compatible with previous Bluetooth standards

## 3. Block Diagram



## 4. General Specification

### 4.1 WI-FI 2.4GHz Specification

| Feature   | Description                               |                |
|---|---|----------------|
| WLAN Standard                                   | IEEE 802.11 b/g/n/ac/ax Wi-Fi compliant   |                |
| Frequency Range                                 | 2.400 GHz ~ 2.4835 GHz (2.4 GHz ISM Band) |                |
| FCC Number of Channels                          | 2.4GHz: Ch1 ~ Ch11                        |                |
| Spectrum Mask                                   | Meet with IEEE standard                   |                |
| Freq. Tolerance                                 | ± 20ppm                                   |                |
| Test Items                                      | Test Value                                | Standard Value |
| SISO Receive Sensitivity (11b,20MHz) @8% PER    | - 11Mbps PER @ -86 dBm                    | ≤-84           |
| SISO Receive Sensitivity (11g,20MHz) @10% PER   | - 54Mbps PER @ -73 dBm                    | ≤-71           |
| SISO Receive Sensitivity (11n,20MHz) @10% PER   | - MCS=7 PER @ -71 dBm                     | ≤-69           |
| SISO Receive Sensitivity (11n,40MHz) @10% PER   | - MCS=7 PER @ -68 dBm                     | ≤-66           |
| SISO Receive Sensitivity (11ax,20MHz) @10% PER  | - MCS=11 PER @ -57 dBm                    | ≤-55           |
| SISO Receive Sensitivity (11ax ,40MHz) @10% PER | - MCS=11 PER @ -56 dBm                    | ≤-54           |
| Maximum Input Level                             | 802.11b : -10 dBm                         |                |
|   | 802.11g/n : -20 dBm                       |                |

### 4.2 WI-FI 5GHz Specification

| Feature         | Description                            |                |
|-----------------|--|----------------|
| WLAN Standard   | IEEE 802.11a/n/ac/ax, Wi-Fi compliant  |                |
| Frequency Range | 5.15 GHz ~ 5.850 GHz(5.0 GHz ISM Band) |                |
| Spectrum Mask   | Meet with IEEE standard                |                |
| Freq. Tolerance | ± 20ppm                                |                |
| Test Items      | Test Value                             | Standard Value |

|  |                             |       |
|--|-----------------------------|-------|
| SISO Receive Sensitivity<br>(11a,20MHz) @10% PER   | - 54Mbps PER @ -70dBm       | ≤-68  |
| SISO Receive Sensitivity<br>(11n,20MHz) @10% PER   | - MCS=7 PER @ -68 dBm       | ≤-66  |
| SISO Receive Sensitivity<br>(11n,40MHz) @10% PER   | - MCS=7 PER @-66 dBm        | ≤-64  |
| SISO Receive Sensitivity<br>(11ac,20MHz) @10% PER  | - MCS=8, NSS1 PER @ -64 dBm | ≤ -62 |
| SISO Receive Sensitivity<br>(11ac ,40MHz) @10% PER | - MCS=9, NSS1 PER @ -60 dBm | ≤ -58 |
| SISO Receive Sensitivity<br>(11ac,80MHz) @10% PER  | - MCS=9, NSS1 PER @ -56 dBm | ≤-54  |
| SISO Receive Sensitivity<br>(11ax,20MHz) @10% PER  | - MCS=11 PER @ -58 dBm      | ≤-56  |
| SISO Receive Sensitivity<br>(11ax ,40MHz) @10% PER | - MCS=11 PER @ -56 dBm      | ≤-54  |
| SISO Receive Sensitivity<br>(11ax,80MHz) @10% PER  | - MCS=11 PER @ -52 dBm      | ≤-50  |
| Maximum Input Level                                | 802.11a/n: -30 dBm          |       |

2. 2.4G,5G output power control by firmware power by rate table, the table value must same with module target power

### 4.3 Bluetooth Specification

| Feature                               | Description   |
|---------------------------------------|---|
| <b>General Specification</b>          |   |
| Bluetooth Standard                    | BDR,EDR(1Mbps & 2Mbps & 3Mbps),LE(1Mbps),2LE(2Mbps) |
| Host Interface                        | UART  |
| Frequency Band                        | 2400 MHz ~ 2483.5 MHz                               |
| Number of Channels                    | 79 channels for classic,40 channels for BLE         |
| Modulation                            | GFSK, $\pi/4$ -DQPSK,8DPSK                          |
| <b>RF Specification</b>               |   |
| <b>Output Power , tolerance ±3 dB</b> |   |
|                                       | <b>CL1(dBm)</b>                                     |
| BDR Output Power                      | 8   |



|   |  |
|---|--|
| EDR Output Power                                      | 8  |
| BLE Output Power                                      | 8  |
| <b>Sensitivity, tolerance : /</b>                     |  |
| Sensitivity @ BER=0.1%<br>for GFSK (1Mbps)            | -85                                      |
| Sensitivity @ BER=0.01%<br>for $\pi/4$ -DQPSK (2Mbps) | -85                                      |
| Sensitivity @ BER=0.01%<br>for 8DPSK (3Mbps)          | -85                                      |
| Sensitivity @ BLE=30.8%<br>for LE (1Mbps)             | -85                                      |
| Sensitivity @ BLE=30.8%<br>for 2LE (2Mbps)            | -85                                      |
| Maximum Input Level                                   | GFSK (1Mbps): $\pm 20\text{dBm}$         |
|   | $\pi/4$ -DQPSK (2Mbps) : $-20\text{dBm}$ |
|   | 8DPSK (3Mbps) : $-20\text{dBm}$          |

Note: The Bluetooth Specification will be updated in future version.

## 5. ID setting information

WI-FI

|            |   |
|------------|---|
| Vendor ID  | - |
| Product ID | - |

### 5.1 List of certified information

| Certification project | Certificate number       |
|-----------------------|--------------------------|
| SRRC                  | CMIIT:ID:24J43T23B983(M) |
| FCC                   | TBD                      |
| CE                    | TBD                      |
| IC                    | TBD                      |
| NCC                   | TBD                      |
| KCC                   | TBD                      |

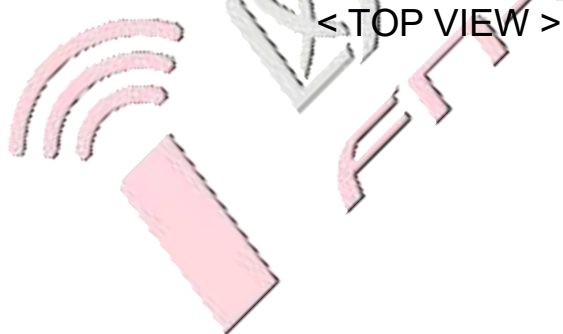
|           |             |
|-----------|-------------|
| TELEC     | TBD         |
| Brazil    | TBD         |
| Argentina | TBD         |
| Japan     | TBD         |
| BQB       | QDID:216641 |

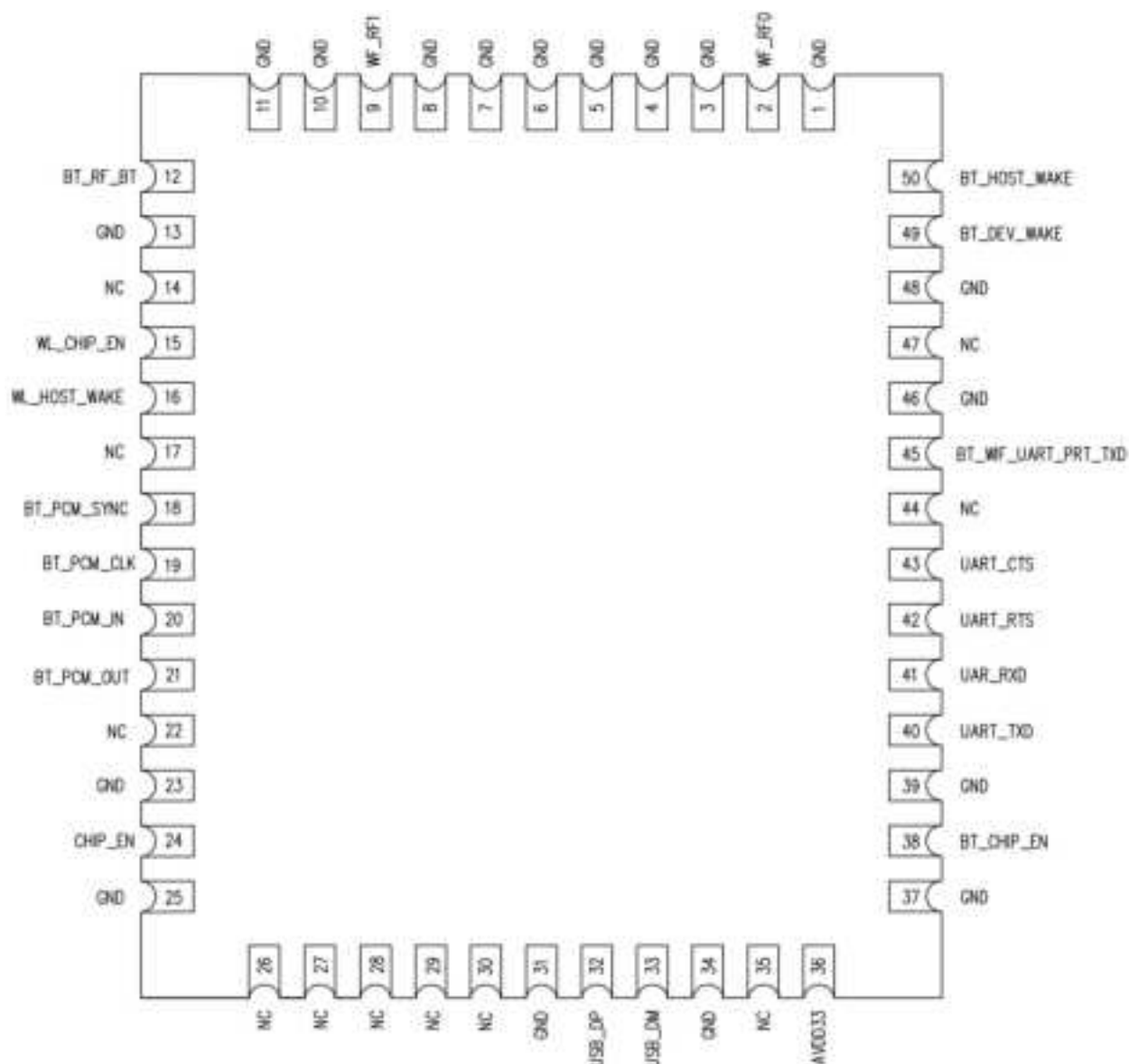
## 5.2 Software protocol, function and other support conditions

| MCC | DBS | BT mode 双模 | LE Advertising Extension | Bluetooth Scatternet |
|-----|-----|------------|--------------------------|----------------------|
|     |     |            |                          |                      |

## 6. Pin Definition

### 6.1 Pin Outline





## 6.2 Pin Definition details

| NO. | Name   | Type | Description                         | Voltage |
|-----|--------|------|-------------------------------------|---------|
| 1   | GND    |      | Ground connections                  |         |
| 2   | WF_RF0 | I/O  | RF I/O port chain0, dual band Wi-Fi |         |
| 3   | GND    |      | Ground connections                  |         |
| 4   | GND    |      | Ground connections                  |         |
| 5   | GND    |      | Ground connections                  |         |
| 6   | GND    |      | Ground connections                  |         |
| 7   | GND    |      | Ground connections                  |         |
| 8   | GND    |      | Ground connections                  |         |
| 9   | WF_RF1 | I/O  | RF I/O port chain1, dual band Wi-Fi |         |

|    |              |     |   |       |
|----|--------------|-----|---|-------|
| 10 | GND          |     | Ground connections  |       |
| 11 | GND          |     | Ground connections  |       |
| 12 | BT_RF_BT     |     | BT antenna  |       |
| 13 | GND          |     | Ground connections  |       |
| 14 | NC           |     | Floating (NC)   |       |
| 15 | WL_CHIP_EN   |     | WLAN Chip Enable, Low asserting reset for WLAN core           |       |
| 16 | WL_HOST_WAKE |     | WLAN device to wake up WLAN HOST                              |       |
| 17 | NC           |     | Floating (NC)   |       |
| 18 | BT_PCM_SYNC  |     | Bluetooth PCM SYNC  |       |
| 19 | BT_PCM_CLK   |     | Bluetooth PCM CLK   |       |
| 20 | BT_PCM_IN    |     | Bluetooth PCM IN  |       |
| 21 | BT_PCM_OUT   |     | Bluetooth PCM OUT   |       |
| 22 | NC           |     | Floating (NC)   |       |
| 23 | GND          |     | Ground connections  |       |
| 24 | CHIP_EN      |     | chip Enable/Disable pin                                       |       |
| 25 | GND          |     | Ground connections  |       |
| 26 | NC           |     | Floating (NC)   |       |
| 27 | NC           |     | Floating (NC)   |       |
| 28 | NC           |     | Floating (NC)   |       |
| 29 | NC           |     | Floating (NC)   |       |
| 30 | NC           |     | Floating (NC)   |       |
| 31 | GND          |     | Ground connections  |       |
| 32 | USB_DP       |     | USB host positive data signal                                 |       |
| 33 | USB_DM       |     | USB host positive data signal                                 |       |
| 34 | GND          |     | Ground connections  |       |
| 35 | NC           |     | Floating (NC)   |       |
| 36 | VDD33        | P   | Main power voltage source input 3.3V                          | 3.3V  |
| 37 | GND          |     | Ground connections  |       |
| 38 | BT_CHIP_EN   |     | Bluetooth CHIP Enable, Low asserting reset for Bluetooth core |       |
| 39 | GND          |     | Ground connections  |       |
| 40 | UART_TXD     | I   | Bluetooth High-Speed UART Data Out                            |       |
| 41 | UART_RXD     | I/O | Bluetooth High-Speed UART Data In                             |       |
| 42 | UART_RTS     |     | UART CTS  | VDDIO |
| 43 | UART_CTS     |     | UART RTS  | 3.3V  |
| 44 | NC           |     | Floating (NC)   |       |

|    |                     |   |                                  |  |
|----|---------------------|---|----------------------------------|--|
| 45 | BT_WIF_UART_PRT_TXD | I | BT LOG Printing                  |  |
| 46 | GND                 |   | Ground connections               |  |
| 47 | NC                  |   | Floating (NC)                    |  |
| 48 | GND                 |   | Ground connections               |  |
| 49 | BT_DEV_WAKE         | I | HOST wake-up Bluetooth device    |  |
| 50 | BT_HOST_WAKE        | I | Bluetooth device to wake-up HOST |  |

P:POWER I:INPUT O:OUTPUT

## 7. Electrical Specifications

### 7.1 Power Supply DC Characteristics

|                       | MIN  | TYP | MAX  | Unit  |
|-----------------------|------|-----|------|-------|
| Operating Temperature | -25  | 25  | 85   | deg.C |
| AVDD33                | 3.14 | 3.3 | 3.63 | V     |
| VDDIO                 | 2.97 | 3.3 | 3.63 |       |

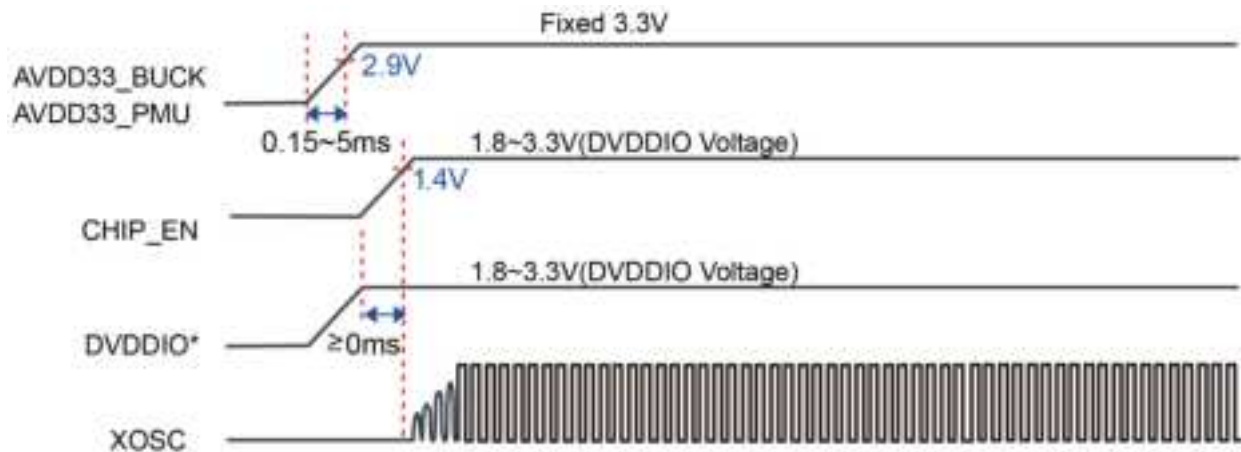
### 7.2 Power Consumption

|                   |                    |            |
|-------------------|--------------------|------------|
| Power Consumption | Wi-Fi only:<br>TBD | BT:<br>TBD |
|-------------------|--------------------|------------|

### 7.3 Interface Circuit time series

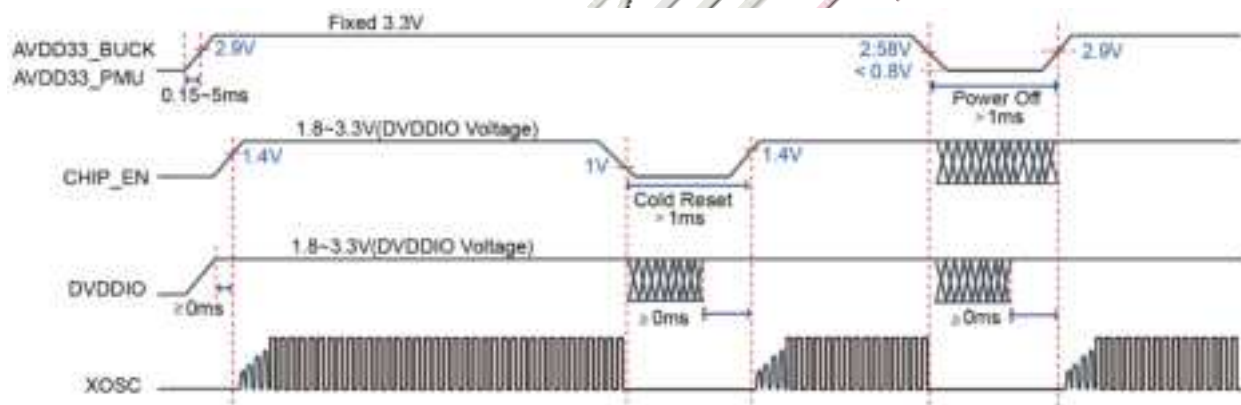
#### 7.3.1 power on sequence

The following figure shows the power on sequence. when AVDD33\_PMU, AVDD33\_BUCK are 3.3V and CHIP\_EN =1.8 V, start power on sequence.



### 7.3.2 Global Reset

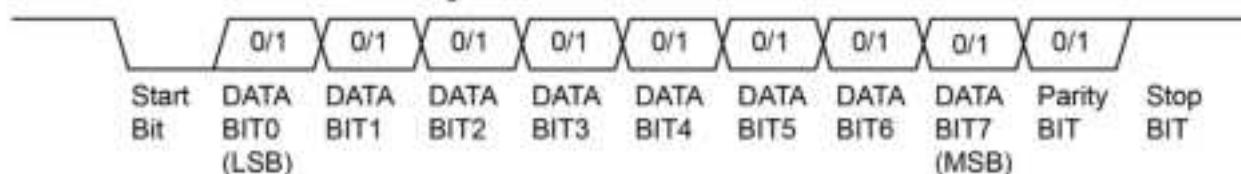
The following figure shows the cold reset sequence. The cold reset is controlled by AVDD33\_PMU, AVDD33\_BUCK and CHIP\_EN.



### 7.3.3 UART

The UART baud rate is set by a configuration register after device is reset and firmware is downloaded, it can be updated by adjusting the baud rate register using HCI UART command on UART interface.

Commonly used baud rates are 4000000b/s, 2000000b/s, 1000000b/s, 921600b/s and 115200b/s. UART interface frame supports Start BIT, Parity BIT and Stop BIT. Parity BIT can be set by UART registers.



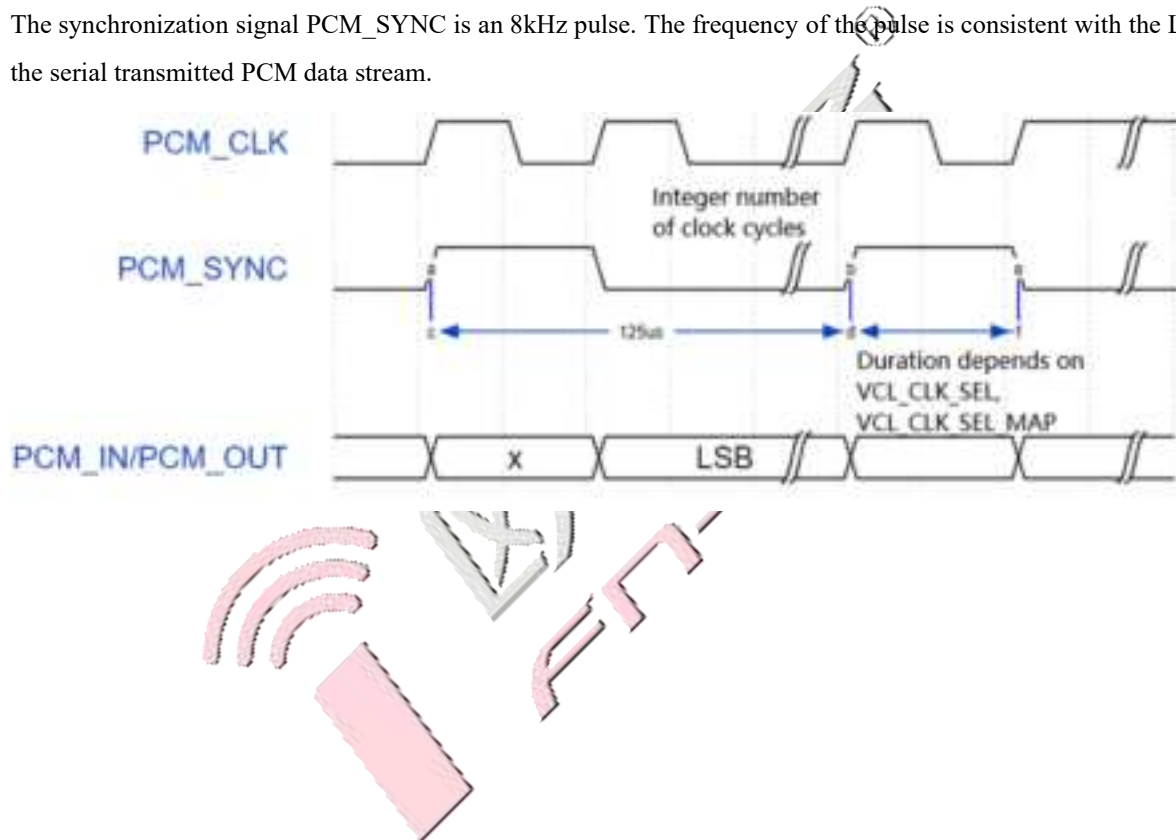
### 7.3.4 PCM

This section describes an interfacing example in which W256U1 can control a voice codec for Bluetooth applications. It supports the following features:

- Supports master and slave mode
- Supports A-law/u-law, and 12/13/14/15/16 bit linear PCM format.
- Supports Master clock output:200kHz,1MHz
- Supports SCO/ESCO packets

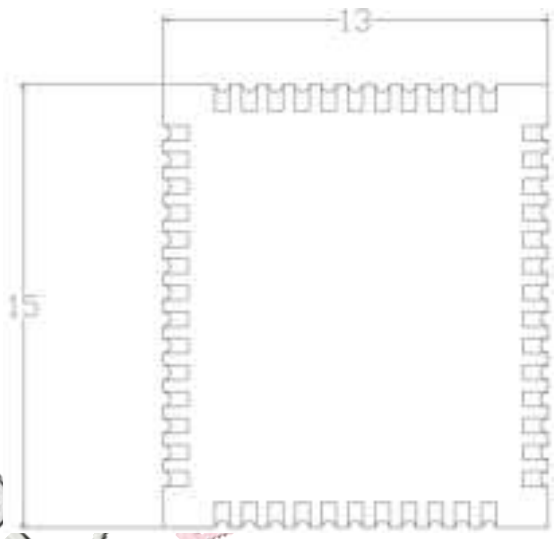

PCM interface has four signals: a synchronization pulse that represents the LSB or MSB signal name PCM\_SYNC when a serial transmission occurs; Clock signal name PCM\_CLK; Two data lines signal names PCM\_IN and PCM\_OUT, one in each direction, these two signals are time synchronized with PCM\_CLK.

The synchronization signal PCM\_SYNC is an 8kHz pulse. The frequency of the pulse is consistent with the LSB of the serial transmitted PCM data stream.



## 8. Size reference

### 8.1 Module Picture

|   |  |
|---|--|
| <p><b>L x W : 15 x 13 (<math>\pm 0.2</math>) mm</b></p> |    |
| <p><b>H: 2.31mm</b></p>                                 |  |
| <p><b>Weight</b></p>                                    | <p>0.92g</p>   |



## 8.2 Marking Description

< TOP VIEW



备注:

二维码内容: 112233445566;FGK265BUUX-01

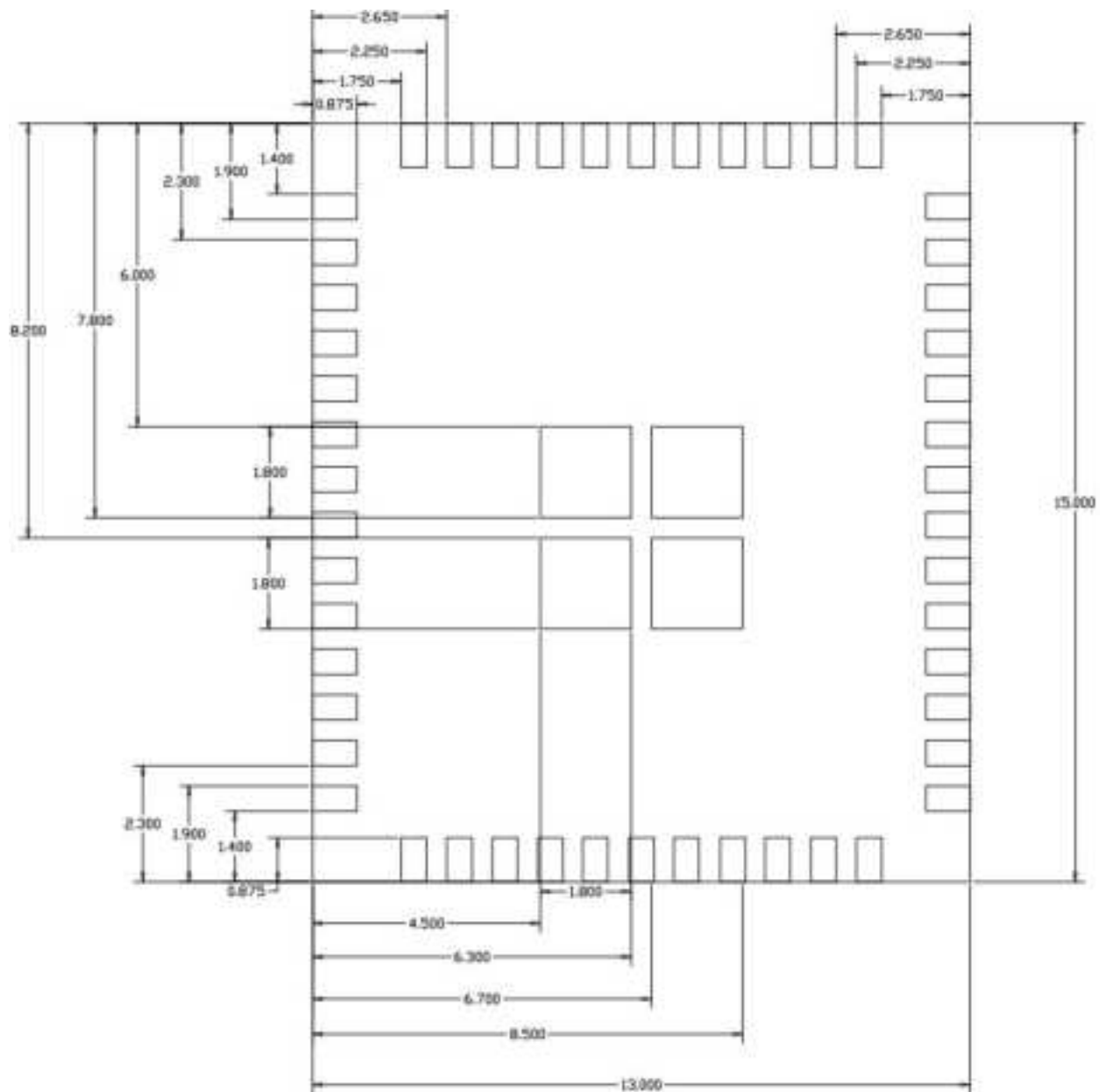
1. Fn-Link 商标 logo
2. 型号: K265B-UU
3. CMIIT ID:24J43T23B983(M)
4. V/N 01(V/N 到 01 之间为两个空格, 01 为成品料号后缀)
5. 二维码: 编码规则为 “wifi mac 地址;成品料号”

例如: 112233445566;FGK265BUUX-01 (MAC 地址以实际为准)

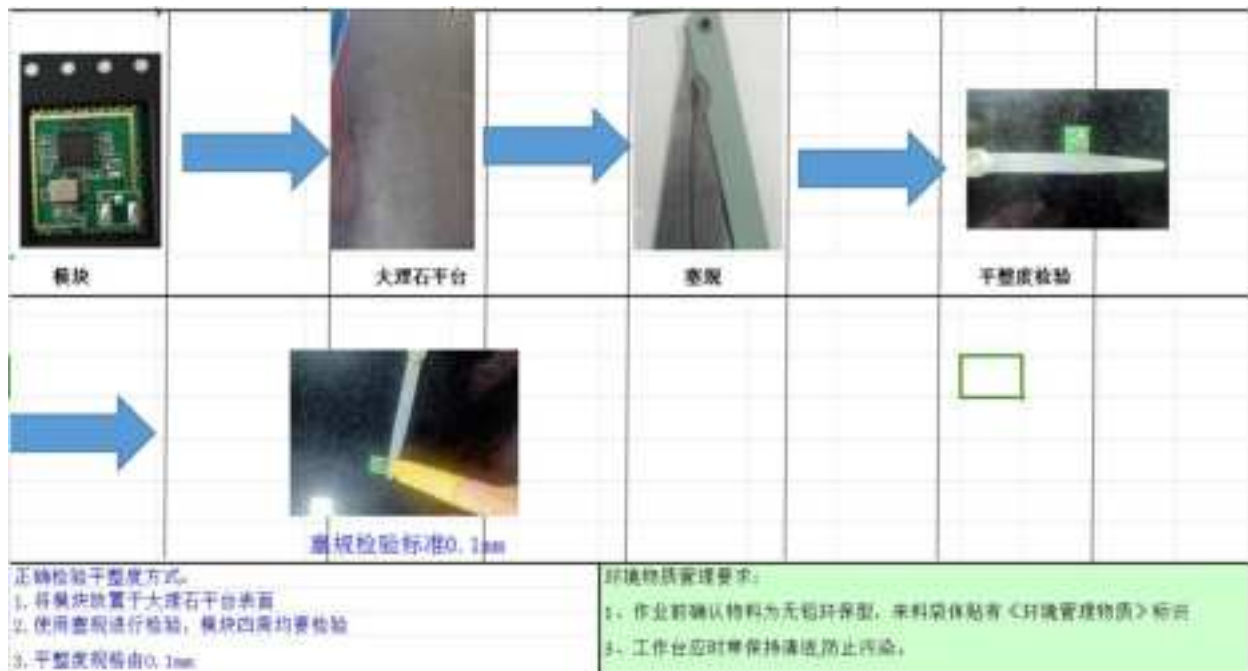
-----BT MAC 在 WIFI MAC 基础上+1 (WIFI地址需跳 1, 不能与 BT 地址重复), 二维码中不显示此内容。



### 8.3 Layout Recommendation



## 8.4 Flat control

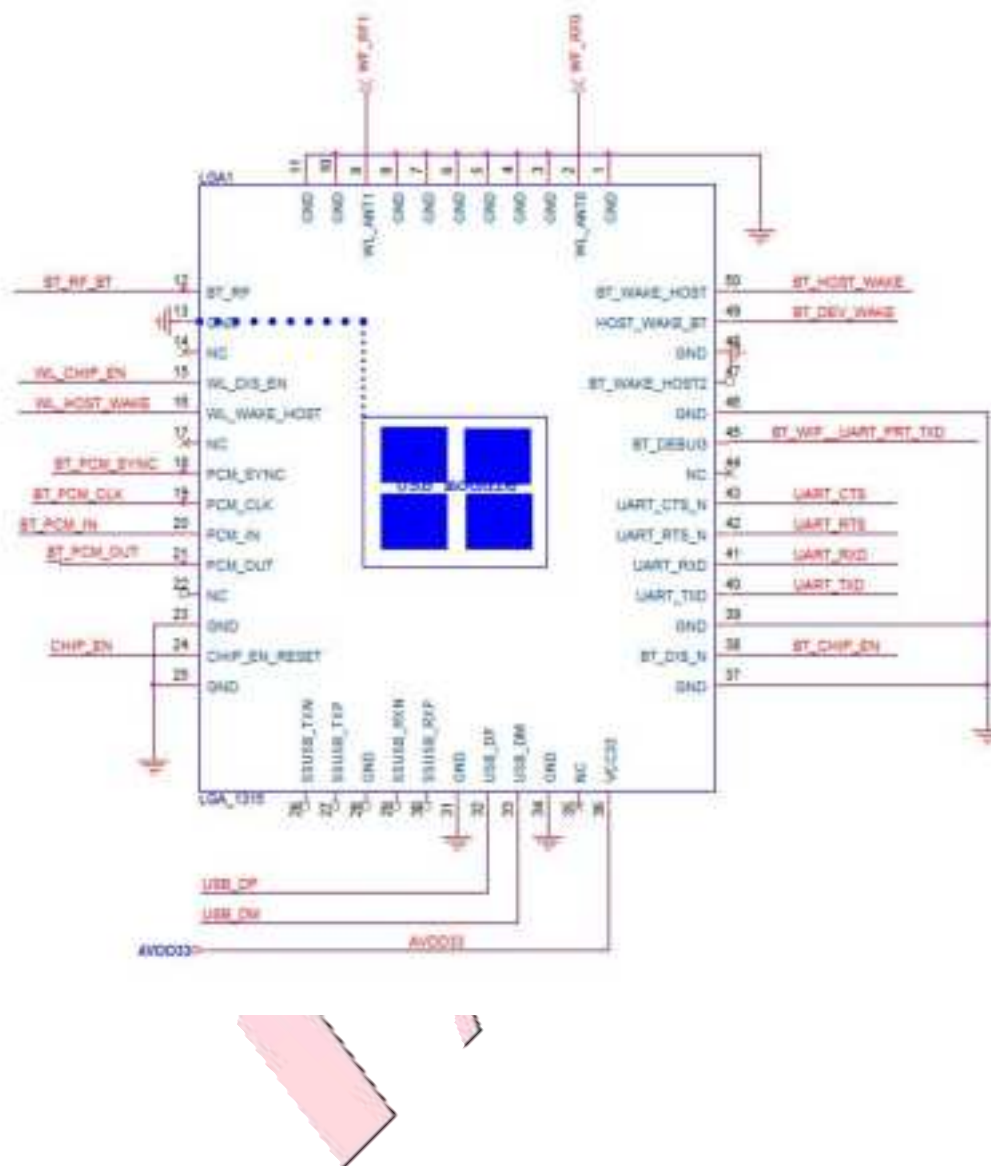


The flatness is 0.1mm

## 9. The Key Material List

| Item | Part Name | Description               | Manufacturer                    |
|------|-----------|---------------------------|---------------------------------|
| 1    | Chipset   | W265U1, QFN76             | Amlogic                         |
| 2    | PCB       | K265B-UU, 4L, 13x15x0.8mm | XY-PCB, KX-PCB, SL-PCB, Sunlord |
| 3    | Crystal   | 2016 40MHZ, 15PF, ±10PPM  | TST, HOSONIC, TKD, ECEC, JWT    |
| 4    | Shielding | K265B-UU shielding        | XINTAI, JLitong                 |
| 5    | Duplexer  |                           | TDK, FEITEER                    |

## 10. Reference Design

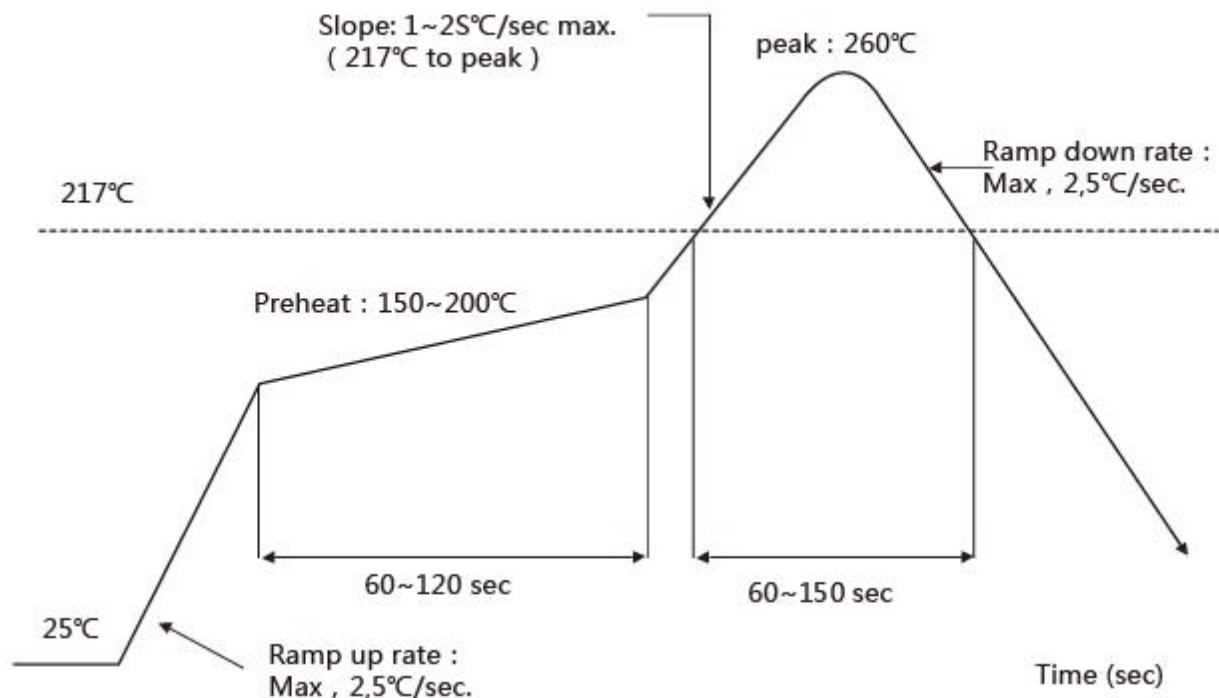


## 11. Recommended Reflow Profile

Referred to IPC/JEDEC standard.

Peak Temperature : <260°C

Number of Times :  $\leq 2$  times



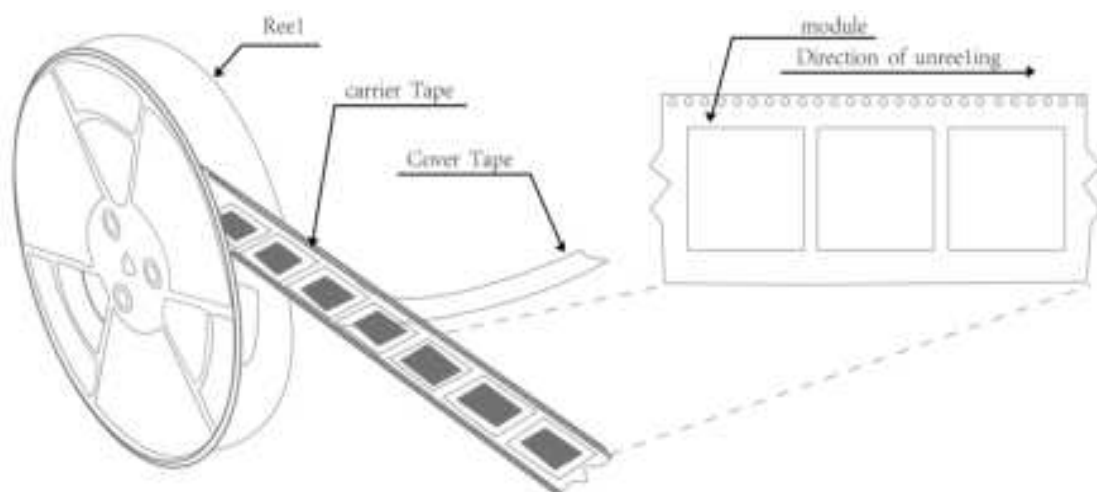
## 12. RoHS compliance

All hardware components are fully compliant with EU RoHS directive

## 13. Package

### 13.1 Reel

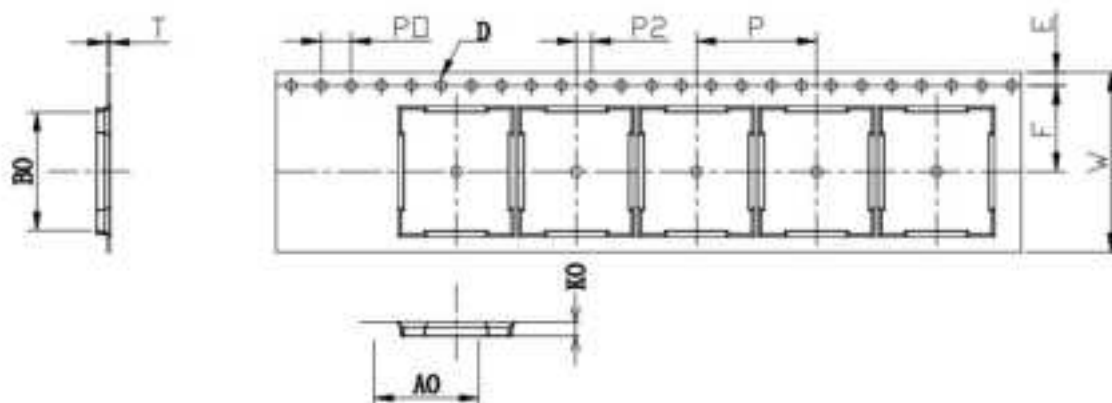
A roll of 1500pcs



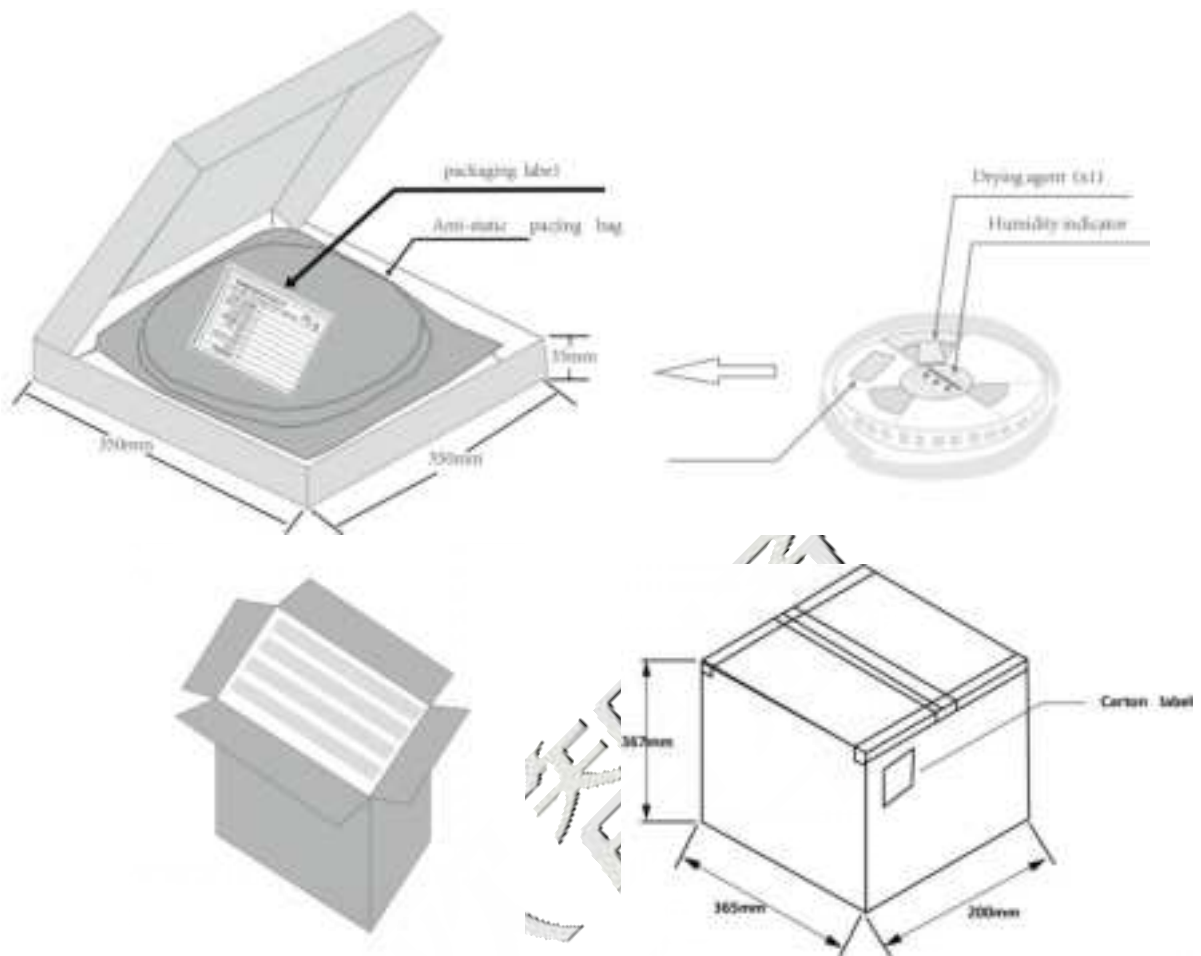
### 13.2 Carrier Tape Detail



| ITEM | W  | A0         | B0         | D  | F  | E         | K0         | P0        | P2        | P         | T          |
|------|--|------------|------------|--|--|-----------|------------|-----------|-----------|-----------|------------|
| DIM  | 24   | 13.40      | 15.40      | 1.50   | 11.5   | 1.75      | 2.65       | 4.0       | 2.0       | 16.0      | 0.30       |
| TOLE | $\begin{smallmatrix} +0.3 \\ -0.3 \end{smallmatrix}$ | $\pm 0.15$ | $\pm 0.15$ | $\begin{smallmatrix} +0.1 \\ -0.2 \end{smallmatrix}$ | $\begin{smallmatrix} +0.1 \\ -0.1 \end{smallmatrix}$ | $\pm 0.1$ | $\pm 0.10$ | $\pm 0.1$ | $\pm 0.1$ | $\pm 0.1$ | $\pm 0.06$ |

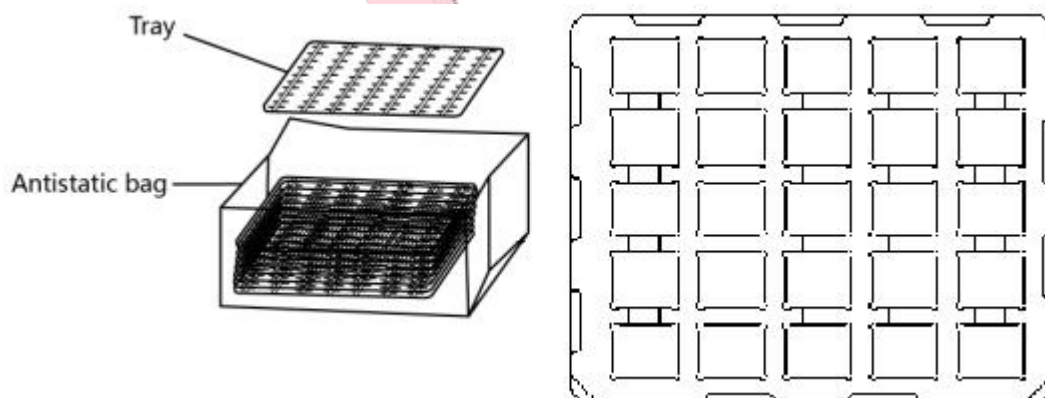


### 13.3 Packaging Detail



### 13.4 Tray

Use pallet packaging for less than 300 pieces





## 14. Moisture sensitivity

The Modules is a Moisture Sensitive Device level 3, in according with standard IPC/JEDEC J-STD-020, take care

all the relatives requirements for using this kind of components.

Moreover, the customer has to take care of the following conditions:

- a) Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
- b) Environmental condition during the production: 30°C / 60% RH according to IPC/JEDEC J-STD-033A paragraph 5
- c) The maximum time between the opening of the sealed bag and the reflow process must be 168 hours if condition
- b) “IPC/JEDEC J-STD-033A paragraph 5.2” is respected
- d) Baking is required if conditions b) or c) are not respected
- e) Baking is required if the humidity indicator inside the bag indicates 10% RH or more

### FCC

#### FCC compliance statement

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) this device may not cause harmful interference, and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### Exposure to radio frequency energy:

The radiated output power of this device meets the limits of FCC radio frequency exposure limits. This device should be operated with a minimum separation distance of 20 cm (8 inches) between the equipment and a person's body.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful



interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### ISED Canada compliance statement:

This device complies with ISED Canada license-exempt RSS standard(s).

Operation is subject to the following two conditions:

- (1) this device may not cause interference, and
- (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Operation in the band 5150 –5350 MHz is only for indoor use to reduce the potential for harmful interference to co-channel mobile satellite systems.

#### Exposure to radio frequency energy:

The radiated output power of this device meets the limits of ISED Canada radio frequency exposure limits. This device should be operated with a minimum separation distance of 20 cm (8 inches) between the equipment and a person's body.

Le présent appareil est conforme aux CNR d'ISDE Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- (1) l'appareil ne doit pas produire de brouillage, et
- (2) l'appareil doit accepter tout brouillage radioélectrique subi, même

si le brouillage est susceptible d'en compromettre le fonctionnement.  
La bande 5150 –5350 MHz est réservée uniquement pour une utilisation à l'intérieur afin de réduire les risques de brouillage préjudiciable aux systèmes de satellites mobiles utilisant les mêmes canaux.

L'exposition à l'énergie radiofréquence.

La puissance de sortie rayonné de cet appareil est conforme aux limites de la ISDE Canada limites d'exposition aux fréquences radio. Cet appareil doit être utilisé avec une distance minimale de séparation de 20 cm entre l'appareil et le corps d'une personne.

Integration instructions for host product manufacturers according to KDB 996369 D03 OEM Manual v01r01

## 2.2 List of applicable FCC rules

FCC Part 15 Subpart C 15.247 & 15.209 & 15.407.

## 2.3 Specific operational use conditions

The module is a WIFI&BT Module with 2.4G&5G function.

WiFi Operation Frequency: 2412~2462MHz; 5180~5320MHz;  
5500~5700MHz;5745~5825MHz.

BT Operation Frequency: 2402~2480MHz,

Type: FPC Antenna

The module can be used for mobile applications with a Gain:

ANT1:maximum 3.58dBi@2.4GHz, 3.37dBi@5GHz antenna gain

ANT2:maximum 3.58dBi@2.4GHz, 3.37dBi@5GHz antenna gain

ANT3(BT):maximum 3.58dBi@2.4GHz

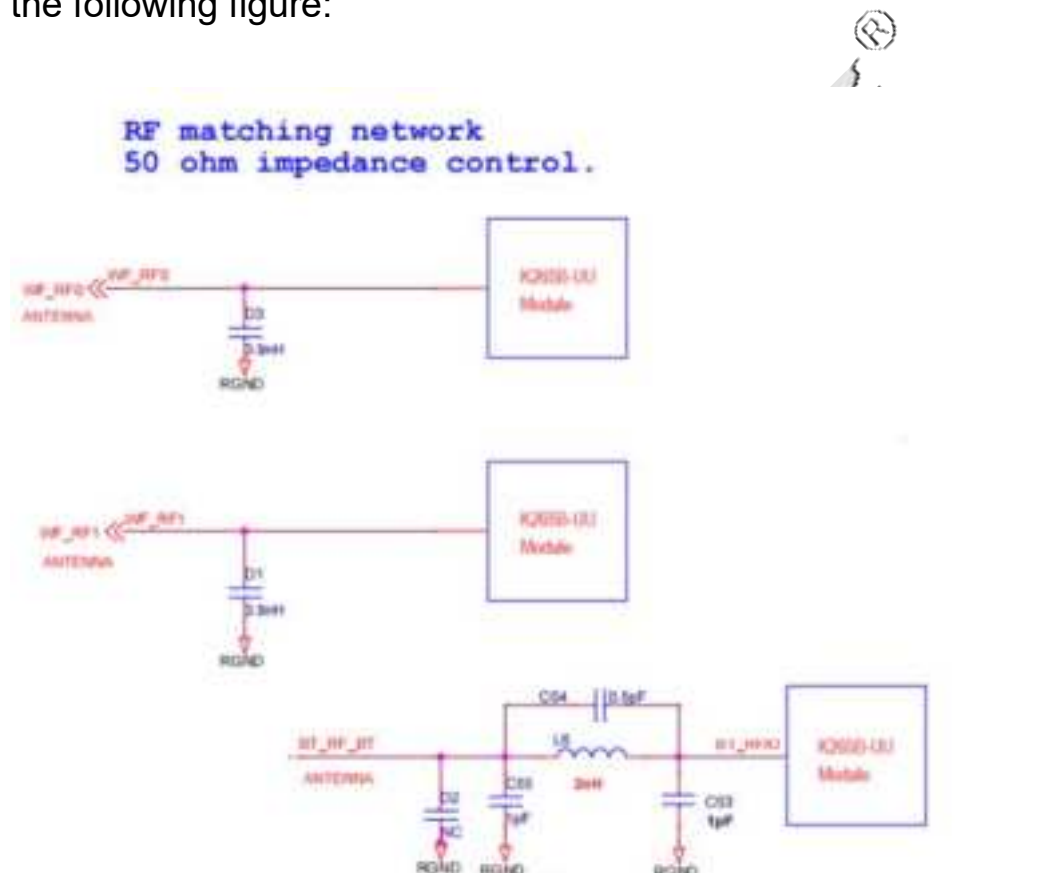
The host manufacturer installing this module into their product must ensure that the final product complies with the FCC requirements by a technical assessment or evaluation to the FCC rules, including the transmitter operation. The host manufacturer has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual.

## 2.4 Limited module procedures

Not applicable The module is a Single module and complies with the requirement of FCC Part 15 212.

## 2.5 Trace antenna designs

When the K265B-UU module is used, a matching circuit needs to be reserved between the WLAN\_ANT,BT\_ANT antenna connector of the module and the antenna connector of the baseboard, and the recommended antenna matching circuit and initial parameters are shown in the following figure:



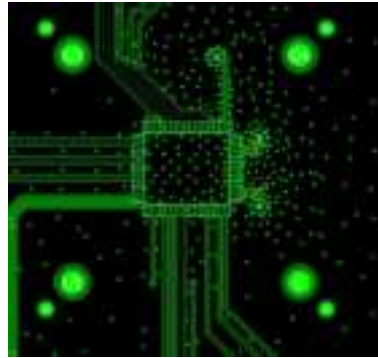
### Wi-Fi&BT antenna reference design circuitry

For the WLAN\_ANT circuit,D1,D3 use 3.9nH inductor.

For BT\_ANT circuit ,L6 use 2nH inductor,C53,C55 use 1pF capacitor,C54 use 0.5pF capacitor ,D2 default, do match reserved, its final value according to the actual debugging results to determine.

Antenna interface to the bottom of the board antenna alignment to ensure

that the impedance control of 50Ω



Layout

ANTENNA MANUFACTURER:South Star Corporation

ANTENNA MODEL:WIFI/BT Antenna

ANTENNA TYPE:FPC ANTENNA

ANTENNA GAIN:

ANT1:3.58dBi@2.4G ,3.37dBi@5G;ANT2:3.58dBi@2.4G ,3.37dBi@5G;ANT3(BT):3.58dBi@2.4G

ANTENNA BANDWIDTH:

ANT1:80MHz@2.4G,700MHz@5G;ANT2:80MHz@2.4G,700MHz@5G;ANT3:80MHz@BT

ANTENNA FREQUENCY:

ANT1:2400-2500MHz,5150-5850MHz;ANT2:2400-2500MHz,5150-5850MHz;ANT3(BT):2400-2500MHz

ANTENNA IMPEDANCE:50 Ω

ANTENNA POLARIZATION:LINEAR POLARIZATION

ANTENNA DIRECTIVITY:

ANT1:4.92dBi@2.4G,6.01dBi@5G;ANT2:4.92dBi@2.4G,6.01dBi@5G;ANT3(BT):4.92dBi@2.4G

ANTENNA FORM FACTOR:12.33mmX20.8mm

## 2.7 Antennas

Antenna Specification are as follows:

Type: FPC Antenna

Gain:

ANT1:maximum 3.58dBi@2.4GHz, 3.37dBi@5GHz antenna gain

ANT2:maximum 3.58dBi@2.4GHz, 3.37dBi@5GHz antenna gain

ANT3(BT):maximum 3.58dBi@2.4GHz

This device is intended only for host manufacturers under the following conditions: The transmitter module may not be co-located with any other transmitter or antenna; The module shall be only used with the internal antenna(s) that has been originally tested and certified with this module. The antenna must be either permanently attached or employ a "unique" antenna coupler. As long as the conditions above are met, further transmitter test will not be required. However, the host manufacturer is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc).

## 2.8 Label and compliance information

Host product manufacturers need to provide a physical or e-label stating "Contains FCC ID: 2AATL-K265B-UU" with their finished product.

## 2.9 Information on test modes and additional testing requirements

Host manufacturer must perform test of radiated & conducted emission and spurious emission, e.t.c according to the actual test modes for a stand-alone modular transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host product. Only when all the test results of test modes comply with FCC requirements, then the end product can be sold legally.

## 2.10 Additional testing, Part 15 Subpart B disclaimer

The modular transmitter is only FCC authorized for FCC Part 15 Subpart C 15.247 & 15.209 & 15.407 and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product as being Part 15 Subpart B compliant (when it also contains unintentional-radiator digital circuitry), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

## 2.11 Note EMI Considerations

Note EMI Considerations: D04 Module Integration Guide has been considered as "best practice" for RF design engineering testing and evaluation of non-linear interactions which can generate additional non-compliant limits due to module placement to host components or properties.

For standalone mode, D04 Module Integration Guide was referenced, and simultaneous mode considered for the host product to confirm compliance.

## 2.12 How to make changes

Only the Grantee is permitted to make permissive changes.

